


 Click [here](#) for the 3D model.

General Information

Series	SMD Auto COG
Style	SMD Chip
Description	SMD, MLCC, Ultra-Stable, Low Loss, Automotive Grade
Features	Ultra-Stable, Low Loss, Automotive Grade
RoHS	Yes
Termination	Tin
Marking	No
Qualifications	AEC-Q200
AEC-Q200	Yes
Typical Component Weight	25 mg
Shelf Life	78 Weeks
MSL	1

Dimensions

L	3.2mm +/-0.2mm
W	1.6mm +/-0.2mm
T	1.1mm +/-0.10mm
S	1.5mm MIN
B	0.5mm +/-0.25mm
Case Code (EIA / mm)	1206 / 3216

Specifications

Capacitance	0.033 uF
Measurement Condition	1 kHz 1.0Vrms
Tolerance	5%
Voltage DC	100 VDC
Dielectric Withstanding Voltage	250 VDC
Temperature Range	-55/+125°C
Temp. Coefficient	COG
Capacitance Change with Reference to +25°C and 0 VDC Applied (TCC)	30 ppm/C, 1 kHz 1.0Vrms
Dissipation Factor	0.1% 1 kHz 1.0Vrms
Aging Rate	0% Loss/Decade Hour
Insulation Resistance	30.303 GOhms

Packaging Specifications

Packaging	T&R, 180mm, Plastic Tape
Packaging Quantity	2500

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